

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Takeo YAMADA	10/04/2010
Takeshi YAMAMOTO	10/04/2010
Takahiro YAMAKURA	10/04/2010
Shinji HAYASHI	10/04/2010
Shingo KAWAI	10/04/2010
RECEIVING PARTY DATA	
Name:	NIRECO CORPORATION
Street Address:	2951-4, Ishikawa-machi, Hachioji-shi
City:	Tokyo
State/Country:	JAPAN
Postal Code:	192-8522
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12904494
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	060626.00098

OP \$40.00 12904494

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**PATENT
 REEL: 025140 FRAME: 0203**

NAME OF SUBMITTER:

Douglas H. Goldhush

Total Attachments: 1

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U.S. ASSIGNMENT

For good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by

[Insert
ASSIGNEE's
Name(s)
Address(es)]

NIRECO CORPORATION
2951-4, Ishikawa-machi, Hachioji-shi
Tokyo, Japan 192-8522

(hereinafter ASSIGNEE), the receipt and sufficiency of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

[Title of
Invention]

FILM THICKNESS MEASURING DEVICE AND FILM THICKNESS MEASURING METHOD

[*If the assignment
is being filed
after the filing of the
application, this
section must be
completed]

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

*filed on _____, Serial No. _____

(Squire, Sanders & Dempsey L.L.P. is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with application and any continuing, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, division, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

[Signature(s)
of Assignor(s)]

<u>Takeo Yamada</u> (SIGNATURE)	<u>Takeo YAMADA</u> (TYPE NAME)	<u>4, Oct. 2010</u> (DATE)
<u>Takeshi Yamamoto</u> (SIGNATURE)	<u>Takeshi YAMAMOTO</u> (TYPE NAME)	<u>4, Oct. 2010</u> (DATE)
<u>Takahiro Yamakura</u> (SIGNATURE)	<u>Takahiro YAMAKURA</u> (TYPE NAME)	<u>4, Oct. 2010</u> (DATE)
<u>Shinji Hayashi</u> (SIGNATURE)	<u>Shinji HAYASHI</u> (TYPE NAME)	<u>4, Oct. 2010</u> (DATE)
<u>Shingo Kawai</u> (SIGNATURE)	<u>Shingo KAWAI</u> (TYPE NAME)	<u>4, Oct. 2010</u> (DATE)

NO LEGALIZATION REQUIRED

PATENT